

Declaration of changes from 5007S to 5007S

● SOFTWARE MODIFICATIONS:

- Protocol Stack changes: No
- MMS/STK/USAT/USIM changes: No
- DM/SUPL/VT/FUMO/SWP/HCI: No
- Other changes detailed:

● HARDWARE MODIFICATIONS:

- Band changes: No
- PCB Layout changes: No
- Main components changes:

	Antenna	Base Band	Transceiver	ASM	Power Amplifier	Tx SAW Filter	Rx SAW Filter	Duplexer
GSM850	No	No	No	Yes	Yes	No	No	No
GSM900	No	No	No	Yes	Yes	No	No	No
GSM1800	No	No	No	Yes	Yes	No	No	No
GSM1900	No	No	No	Yes	Yes	No	No	No
UMTS1900	No	No	No	Yes	Yes	No	No	No
UMTS1700	No	No	No	Yes	Yes	No	No	No
UMTS850	No	No	No	Yes	Yes	No	No	No
LTE 2	No	No	No	Yes	Yes	No	No	No
LTE 4	No	No	No	Yes	Yes	No	No	No
LTE 5	No	No	No	Yes	Yes	No	No	No
LTE 12	No	No	No	Yes	Yes	No	No	No
LTE 13	No	No	No	Yes	Yes	No	No	No
LTE 66	No	No	No	Yes	Yes	No	No	No
Bluetooth	No	No	No	No	No	No	No	No
WiFi	No	No	No	No	No	No	No	No

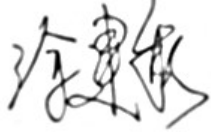
- FM changes: No
- Other components changes:
- Other changes detailed:

● MECHANICAL MODIFICATIONS:

- Use new metal front/back cover or keypad: No
- Mechanical shell changes:
Whole size of EUT: No
Distance of Ear reference point to bottom of handset: No
Other trinkets to change the surface of handset: No
- Other changes detailed:

APPROVED BY:

Project Manager: 涂建能

A handwritten signature in Chinese characters, appearing to be '李建新' (Li Jianxin), written in black ink.

Signature:

Date: 2021-07-30